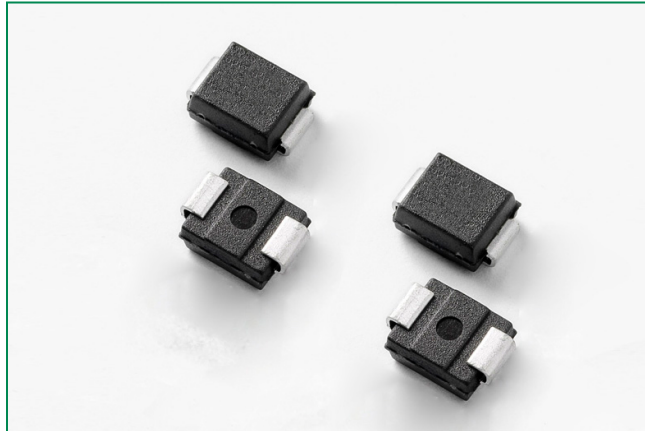


### Automotive PLED Series (PLEDxS-A)



#### Description

Automotive PLED Series (PLEDxS-A) open LED protectors provide a switching electronic shunt path when an LED in an LED string fails as an open circuit. This ensures that the remaining string of LEDs will continue to function if a single LED does not.

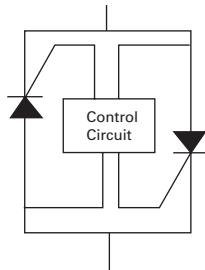
This series is designed for automotive applications such as automotive car head lamp, tail lamp, LED indicator protection, aircraft runway lighting and other applications need high reliability requirements.

Compatible with one, two and three watt LEDs that have a nominal 3V forward characteristic.

#### Agency Approvals

| Agency | Agency File Number |
|--------|--------------------|
|        | E133083            |

#### Schematic Symbol



#### Features

- Recognized to UL 497B as an Isolated Loop Circuit Protector
- AEC-Q101 Qualified and PPAP Capable
- Fast switching
- Automatically resets after power cycle
- Available in standard DO-214AA package
- Compatible with industrial lighting environments
- IEC-61000-4-2 ESD 30kV (Air), 30kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2 (IEC801-2)
- Compatible with PWM frequencies up to 30 kHz
- RoHS compliant and halogen-free

#### Electrical Characteristics (All parameters are measured at $T_A = 25^\circ\text{C}$ unless otherwise noted)

| Part Number | Marking | $V_{\text{DRM}}$<br>@ $I_{\text{DRM}} = 5\mu\text{A}$ | $V_s$<br>@ $100\text{V}/\mu\text{s}$ | $I_H$ | $I_s$ | $I_T @ V_T$ | $V_T @ I_T = 1\text{Amp}$ | Critical rate of rise $dV/dt$ |
|-------------|---------|-------------------------------------------------------|--------------------------------------|-------|-------|-------------|---------------------------|-------------------------------|
|             |         | Volts                                                 | Volts                                | mAmps | mAmps | Amps        | Volts                     | Volts                         |
|             |         | Min                                                   | Max                                  | Min   | Max   | Max         | Max                       | Max                           |
| PLED6S-A    | AL6     | 6                                                     | 27                                   | 5     | 100   | 1.0         | 1.2                       | 250V/ $\mu\text{s}$           |
| PLED9S-A    | AL9     | 9                                                     | 30                                   | 5     | 100   | 1.0         | 1.2                       | 250V/ $\mu\text{s}$           |
| PLED13S-A   | AL13    | 13                                                    | 44                                   | 5     | 100   | 1.0         | 1.2                       | 250V/ $\mu\text{s}$           |
| PLED18S-A   | AL18    | 18                                                    | 55                                   | 5     | 100   | 1.0         | 1.2                       | 250V/ $\mu\text{s}$           |

### Thermal Considerations

| Symbol          | Parameter                               | Value                                                   | Unit |
|-----------------|-----------------------------------------|---------------------------------------------------------|------|
| $T_J$           | Operating Junction Temperature Range    | -55 to +150                                             | °C   |
| $T_S$           | Storage Temperature Range               | -65 to +150                                             | °C   |
| $R_{\theta JA}$ | Thermal Resistance: Junction to Ambient | DO-214AA: 125 <sup>1</sup><br>DO-214AA: 40 <sup>2</sup> | °C/W |

Notes:

1) Standard FR-4 PCB with Copper Pads (Recommended Size)

2) Aluminium PCB

Thickness: 1.6mm

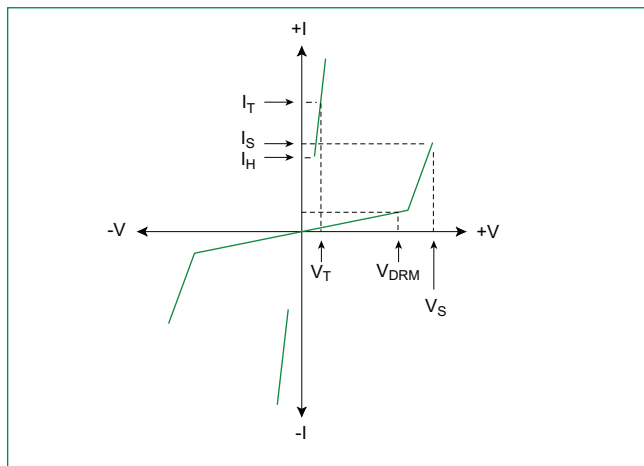
Grade: 1-2 W/mK Thermal Conductivity

Trace thickness: 2 oz

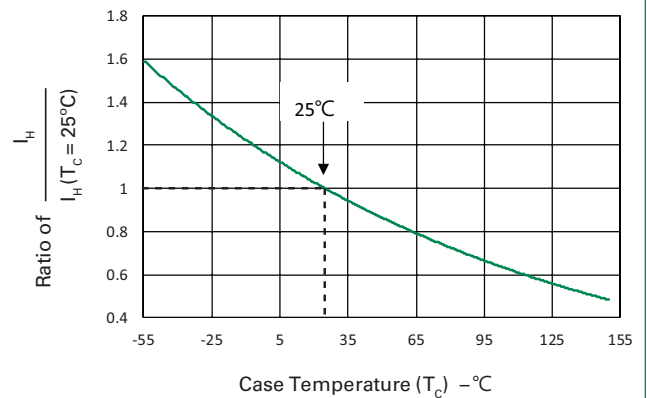
Insulation layer thickness: 215 µm

Solder Pad Dimensions: 2.0mm x 2.8mm (Recommended Size)

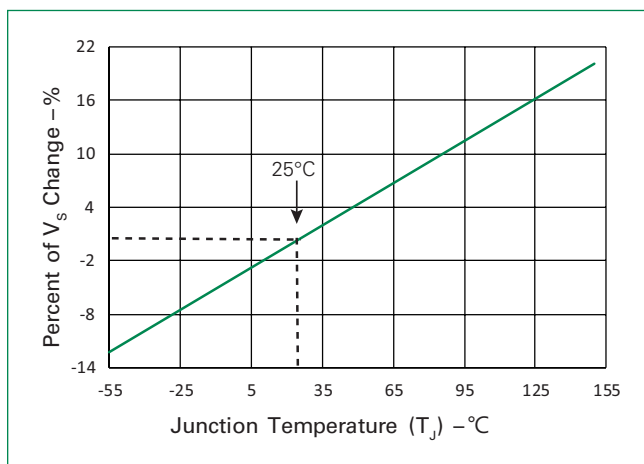
### V-I Characteristics



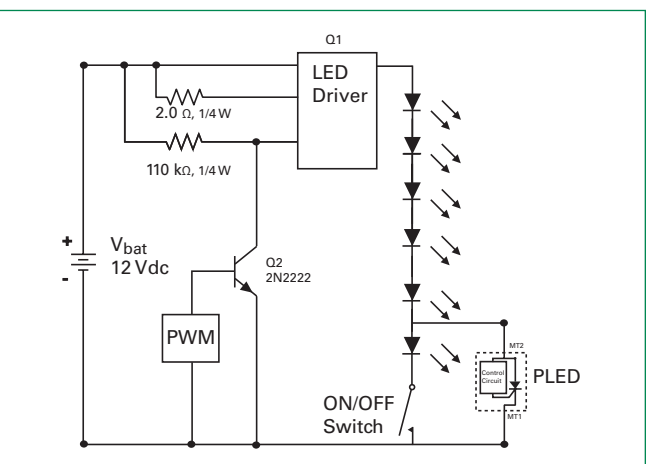
### Normalized DC Holding Current vs. Case Temperature



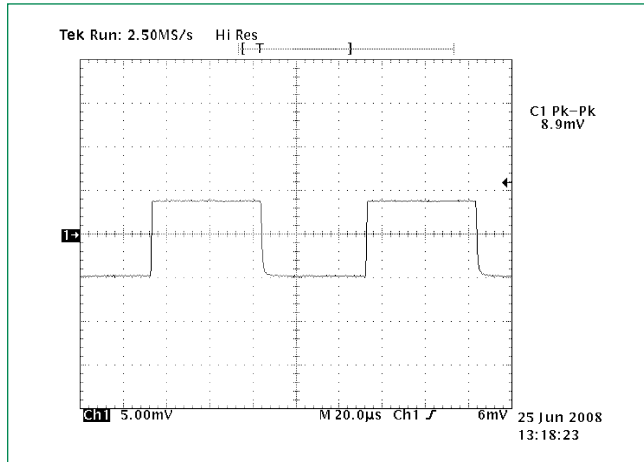
### Normalized V<sub>S</sub> Change vs. Junction Temperature



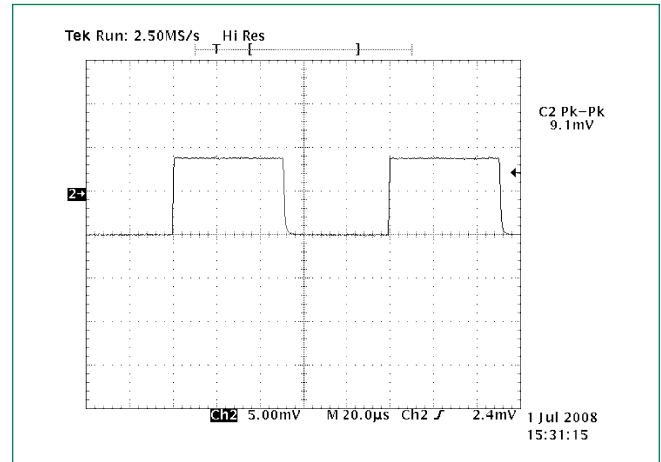
### LED Interference Test Circuit



### 6 LEDs in Series 50% Duty Cycle 10kHz

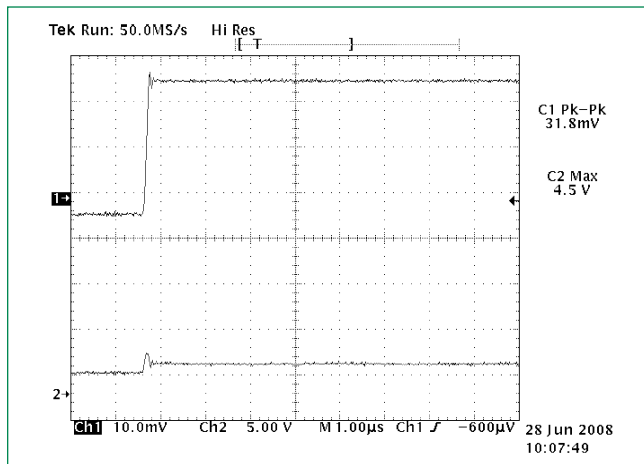


### 5 LEDs and 1 PLED in Series 50% Duty Cycle 10kHz



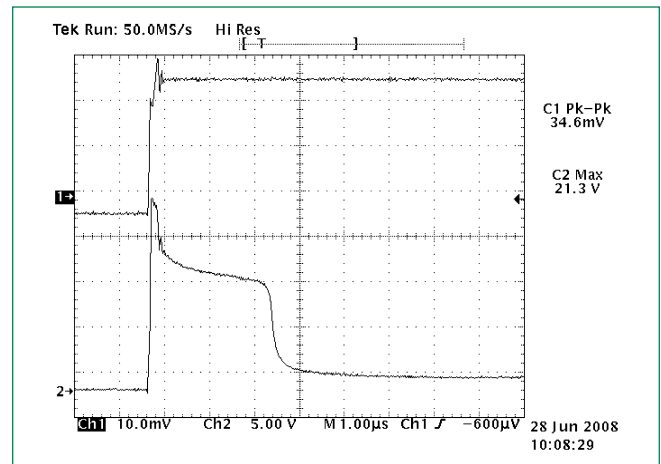
Note: These two graphs show the current magnitude through the LED string with and without the PLED included. There is no noticeable effect on the LED current magnitude when the PLED is included in the circuit as compared to the LED current magnitude when the PLED is not in the circuit. (The conversion factor for the test measurement in the graphs above is 10mA/mV for the Pearson coil measurement, therefore, the current magnitude in the first figure is 10mA\*8.9 = 89mA, while the second figure is 91mA.)

### PLED in the Off-State 10kHz



Channel 1: current through LEDs (318 mA)  
Channel 2: voltage across PLED component (4.5 V)

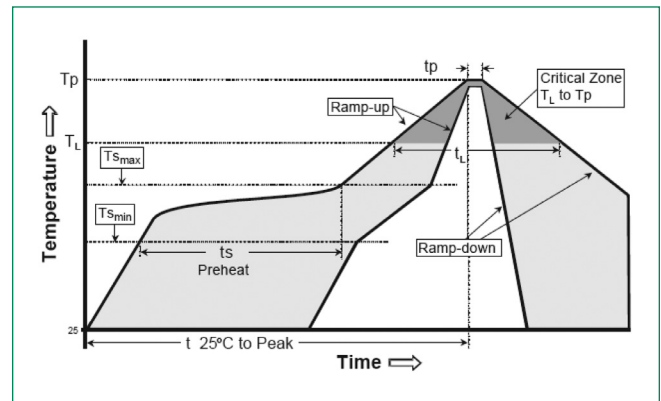
### PLED component zeners and then turns fully on 10kHz



Channel 1: current through LEDs (346 mA) and PLED component once it is fully turned on 2.5 µsec later  
Channel 2: voltage across PLED component (21.3 V before PLED crowbars with 2 V drop)

### Soldering Parameters

|                                                        |                                    |                         |
|--------------------------------------------------------|------------------------------------|-------------------------|
| Reflow Condition                                       |                                    | Pb – Free assembly      |
| Pre Heat                                               | - Temperature Min ( $T_{s(min)}$ ) | 150°C                   |
|                                                        | - Temperature Max ( $T_{s(max)}$ ) | 200°C                   |
|                                                        | - Time (min to max) ( $t_s$ )      | 60 – 180 secs           |
| Average ramp up rate (Liquidus Temp ( $T_L$ ) to peak) |                                    | 3°C/second max          |
| $T_{s(max)}$ to $T_L$ - Ramp-up Rate                   |                                    | 3°C/second max          |
| Reflow                                                 | - Temperature ( $T_L$ ) (Liquidus) | 217°C                   |
|                                                        | - Temperature ( $t_L$ )            | 60 – 150 seconds        |
| Peak Temperature ( $T_p$ )                             |                                    | 260 <sup>+0/-5</sup> °C |
| Time within 5°C of actual peak Temperature ( $t_p$ )   |                                    | 30 seconds              |
| Ramp-down Rate                                         |                                    | 6°C/second max          |
| Time 25°C to peak Temperature ( $T_p$ )                |                                    | 8 minutes max           |
| Do not exceed                                          |                                    | 260°C                   |



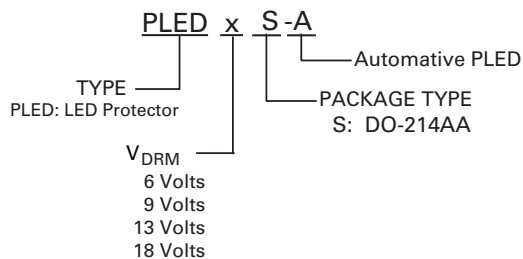
### Physical Specifications

|                          |                                                                |
|--------------------------|----------------------------------------------------------------|
| <b>Terminal Material</b> | Copper Alloy                                                   |
| <b>Terminal Finish</b>   | 100% Matte Tin Plated                                          |
| <b>Body Material</b>     | UL recognized compound meeting flammability classification V-0 |

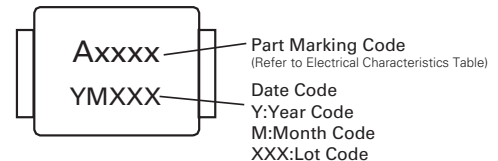
### Environmental Specifications

|                                                |                                                                                                      |
|------------------------------------------------|------------------------------------------------------------------------------------------------------|
| <b>High Temp Voltage Blocking</b>              | 80% Rated $V_{DRM}$ ( $V_{DC}$ Peak) +150°C, 1008 hrs. MIL-STD-750 (Method 1040) JEDEC, JESD22-A-101 |
| <b>Temp Cycling</b>                            | -55°C to +150°C, 15 min. dwell, 1000 cycles. MIL-STD-750 (Method 1051) EIA/JEDEC, JESD22-A104        |
| <b>Biased Temp &amp; Humidity</b>              | 80% Rated $V_{DRM}$ (+85°C) 85%RH, 504 up to 1008 hrs. EIA/JEDEC, JESD22-A-101                       |
| <b>Unbiased Highly Accelerated Stress Test</b> | +130°C, 85%RH, 2atm, 96hrs. JESD22-A-118                                                             |
| <b>Resistance to Solder Heat</b>               | +260°C, 10 secs. MIL-STD-750 (Method 2031)                                                           |
| <b>Moisture Sensitivity Level</b>              | 85%RH, +85°C, 168 hrs., 3 reflow cycles (+260°C Peak). JEDEC-J-STD-020, Level 1                      |

### Part Numbering System



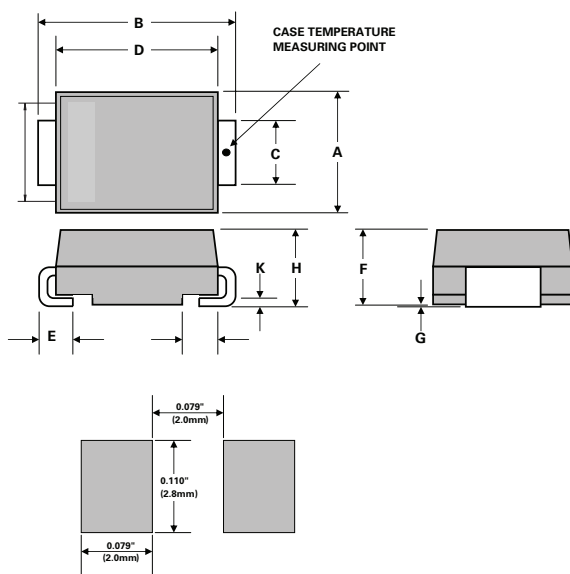
### Part Marking System



### Packaging

| Package | Description | Packaging Quantity | Industry Standard |
|---------|-------------|--------------------|-------------------|
| S       | DO-214AA    | 2500               | EIA-481-1         |

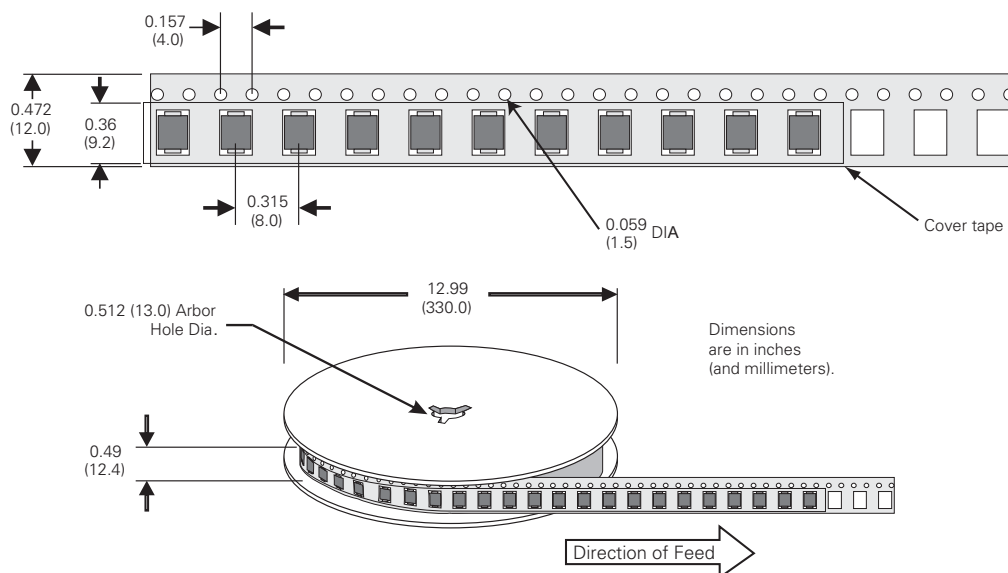
### Dimensions - DO-214 AA Package



Recommended solder pad layout  
(Reference Only)

| Dimensions | Inches |       | Millimeters |      |
|------------|--------|-------|-------------|------|
|            | Min    | Max   | Min         | Max  |
| A          | 0.130  | 0.156 | 3.30        | 3.95 |
| B          | 0.201  | 0.220 | 5.10        | 5.60 |
| C          | 0.077  | 0.087 | 1.95        | 2.20 |
| D          | 0.159  | 0.181 | 4.05        | 4.60 |
| E          | 0.030  | 0.063 | 0.75        | 1.60 |
| F          | 0.075  | 0.096 | 1.90        | 2.45 |
| G          | 0.002  | 0.008 | 0.05        | 0.20 |
| H          | 0.077  | 0.104 | 1.95        | 2.65 |
| K          | 0.006  | 0.016 | 0.15        | 0.41 |

### DO-214AA Embossed Carrier Reel Pack (RP)



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